MC74HC11A

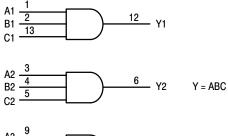
Triple 3-Input AND Gate

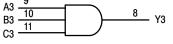
High-Performance Silicon-Gate CMOS

The MC74HC11A is identical in pinout to the LS11. The device inputs are compatible with standard CMOS outputs; with pullup resistors, they are compatible with LSTTL outputs.

Features

- Output Drive Capability: 10 LSTTL Loads
- Outputs Directly Interface to CMOS, NMOS, and TTL
- Operating Voltage Range: 2 V to 6 V
- Low Input Current: 1 µA
- High Noise Immunity Characteristic of CMOS Devices
- NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free and are RoHS Compliant





PIN 14 = V_{CC} PIN 7 = GND

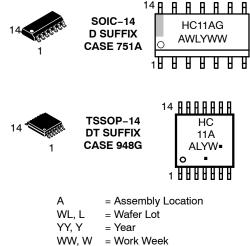
Figure 1. Logic Diagram



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MARKING DIAGRAMS



| ••••, | •• | |
|-------|----|-------------------|
| G or | | = Pb-Free Package |

(Note: Microdot may be in either location)

| ASS | IGNME | NT |
|-----|-----------------------------|-------------------------------------|
| 1• | 14 | l v _{cc} |
| 2 | 13 |] C1 |
| | 12 |] Y1 |
| 4 | 11 |] C3 |
| 5 | 10 |] B3 |
| 6 | 9 |] A3 |
| 7 | 8 |] Y3 |
| | 1● 2 3 4 5 6 | 2 13 3 12 4 11 5 10 6 9 |

FUNCTION TABLE

| Inputs | | | Output |
|--------|---|---|--------|
| Α | В | С | Y |
| L | х | Х | L |
| Х | L | Х | L |
| Х | Х | L | L |
| н | Н | н | н |

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 4 of this data sheet.

MAXIMUM RATINGS*

| Symbol | Parameter | | Value | Unit |
|------------------|---|-------------------------------|------------------------------|------|
| V _{CC} | DC Supply Voltage (Referenced | to GND) | -0.5 to +7.0 | V |
| V _{in} | DC Input Voltage (Referenced to | o GND) | –0.5 to V _{CC} +0.5 | V |
| V _{out} | DC Output Voltage (Referenced | –0.5 to V _{CC} +0.5 | V | |
| l _{in} | DC Input Current, per Pin | ±20 | mA | |
| I _{out} | DC Output Current, per Pin | | ±25 | mA |
| I _{CC} | DC Supply Current, V _{CC} and GI | ND Pins | ±50 | mA |
| P _D | Power Dissipation in Still Air | SOIC Package TSSOP Package | 500 450 | mW |
| T _{stg} | Storage Temperature | | -65 to +150 | °C |

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high–impedance circuit. For proper operation, V_{in} and V_{out} should be constrained to the range GND $\leq (V_{in} \text{ or } V_{out}) \leq V_{CC}$.

Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or V_{CC}). Unused outputs must be left open.

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

RECOMMENDED OPERATING CONDITIONS

| Symbol | Parameter | | | Max | Unit |
|------------------------------------|--|--|-------------|---------------------------|------|
| V _{CC} | DC Supply Voltage (Referenced to GND) | | 2.0 | 6.0 | V |
| V _{in} , V _{out} | DC Input Voltage, Output Voltage (Referenced to GND) | | | V _{CC} | V |
| T _A | Operating Temperature, All Package Types | | -55 | +125 | °C |
| t _r , t _f | (Figure 2) V _{CC} | C = 2.0 V C = 3.0 V C = 4.5 V C = 6.0 V | 0 0 0 | 1000 600 500 400 | ns |

MC74HC11A

| | | | | Guaranteed Limit | | mit | |
|-----------------|---|--|--------------------------|---------------------------|---------------------------|---------------------------|------|
| Symbol | Parameter | Test Conditions | V _{CC} V | - 55 to 25°C | ≤ 85 °C | ≤ 125°C | Unit |
| V _{IH} | Minimum High-Level Input Voltage | $\label{eq:Vout} \begin{array}{l} V_{out} = 0.1 \ V \ \text{or} \ V_{CC} - 0.1 \ V \\ I_{out} \ \leq \ 20 \ \mu A \end{array}$ | 2.0 3.0 4.5 6.0 | 1.5 2.1 3.15 4.2 | 1.5 2.1 3.15 4.2 | 1.5 2.1 3.15 4.2 | V |
| V _{IL} | Maximum Low-Level Input Voltage | $\label{eq:Vout} \begin{array}{l} V_{out} = 0.1 \ V \ \text{or} \ V_{CC} - 0.1 \ V \\ I_{out} \ \leq \ 20 \ \mu A \end{array}$ | 2.0 3.0 4.5 6.0 | 0.5 0.9 1.35 1.8 | 0.5 0.9 1.35 1.8 | 0.5 0.9 1.35 1.8 | V |
| V _{OH} | Minimum High-Level Output Voltage | $V_{in} = V_{IH} \text{ or } V_{IL}$ $ I_{out} \le 20 \ \mu A$ | 2.0 4.5 6.0 | 1.9 4.4 5.9 | 1.9 4.4 5.9 | 1.9 4.4 5.9 | V |
| | | $ \begin{aligned} V_{in} = V_{IH} \text{ or } V_{IL} & \begin{array}{l} I_{out} \leq 2.4 \text{ mA} \\ I_{out} \leq 4.0 \text{ mA} \\ I_{out} \leq 5.2 \text{ mA} \end{aligned} $ | 3.0 4.5 6.0 | 2.48 3.98 5.48 | 2.34 3.84 5.34 | 2.20 3.70 5.20 | |
| V _{OL} | Maximum Low-Level Output Voltage | $V_{in} = V_{IH}$ $ I_{out} \le 20 \ \mu A$ | 2.0 4.5 6.0 | 0.1 0.1 0.1 | 0.1 0.1 0.1 | 0.1 0.1 0.1 | V |
| | | $ \begin{array}{ll} V_{in} = V_{IH} \text{ or } V_{IL} & \begin{array}{ll} I_{out} \leq 2.4 \text{ mA} \\ I_{out} \leq 4.0 \text{ mA} \\ I_{out} \leq 5.2 \text{ mA} \end{array} $ | 3.0 4.5 6.0 | 0.26 0.26 0.26 | 0.33 0.33 0.33 | 0.40 0.40 0.40 | |
| l _{in} | Maximum Input Leakage Current | V _{in} = V _{CC} or GND | 6.0 | ± 0.1 | ± 1.0 | ± 1.0 | μA |
| I _{CC} | Maximum Quiescent Supply Current (per Package) | $V_{in} = V_{CC} \text{ or } GND$ $I_{out} = 0 \ \mu A$ | 6.0 | 1 | 10 | 40 | μA |

DC ELECTRICAL CHARACTERISTICS (Voltages Referenced to GND)

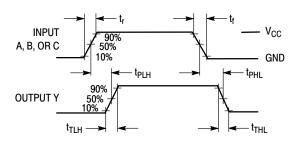
AC ELECTRICAL CHARACTERISTICS (C_L = 50 pF, Input $t_r = t_f = 6 \text{ ns}$)

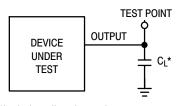
| | | | Guaranteed Limit | | mit | |
|--|--|--------------------------|----------------------|-----------------------|-----------------------|------|
| Symbol | Parameter | V _{CC} V | - 55 to 25°C | ≤ 85°C | ≤ 125°C | Unit |
| t _{PLH} , t _{PHL} | Maximum Propagation Delay, Input A, B, or C to Output Y (Figures 2 and 3) | 2.0 3.0 4.5 6.0 | 95 45 19 16 | 120 60 24 20 | 145 75 29 25 | ns |
| t _{TLH} , t _{THL} | Maximum Output Transition Time, Any Output (Figures 2 and 3) | 2.0 3.0 4.5 6.0 | 75 30 15 13 | 95 40 19 16 | 110 55 22 19 | ns |
| C _{in} | Maximum Input Capacitance | - | 10 | 10 | 10 | pF |

| | | Typical @ 25°C, V _{CC} = 5.0 V | |
|-----------------|---|---|----|
| C _{PD} | Power Dissipation Capacitance (Per Gate)* | 27 | pF |

*Used to determine the no-load dynamic power consumption: $P_D = C_{PD} V_{CC} 2f + I_{CC} V_{CC}$.

MC74HC11A

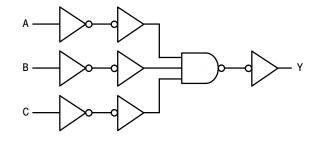


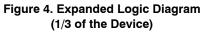


*Includes all probe and jig capacitance

Figure 3. Test Circuit

Figure 2. Switching Waveforms





ORDERING INFORMATION

| Device | Package | Shipping [†] |
|-----------------|-----------------------|-----------------------|
| MC74HC11ADG | SOIC-14 (Pb-Free) | 55 Units / Rail |
| MC74HC11ADR2G | SOIC-14 (Pb-Free) | 2500 / Tape & Reel |
| MC74HC11ADTG | TSSOP-14 (Pb-Free) | 96 Units / Tube |
| MC74HC11ADTR2G | TSSOP-14 (Pb-Free) | 2500 / Tape & Reel |
| NLV74HC11ADR2G* | SOIC-14 (Pb-Free) | 2500 / Tape & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

*NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q100 Qualified and PPAP Capable

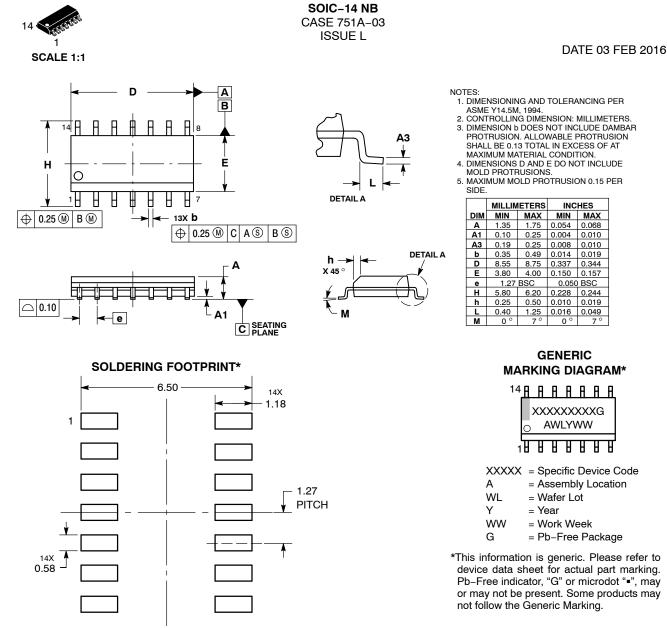
DUSEM

0.068

0.019

0.344

0.244



DIMENSIONS: MILLIMETERS

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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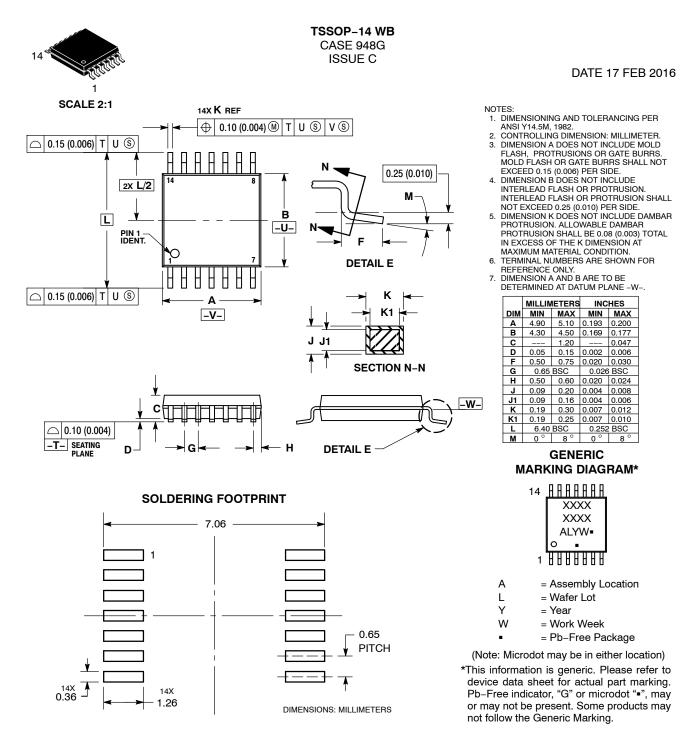
| STYLE 1: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. NO CONNECTION 5. ANODE/CATHODE 6. NO CONNECTION 7. ANODE/CATHODE 8. ANODE/CATHODE 9. ANODE/CATHODE 10. NO CONNECTION 11. ANODE/CATHODE 12. ANODE/CATHODE 13. NO CONNECTION 14. COMMON ANODE | STYLE 2: CANCELLED | STYLE 3: PIN 1. NO CONNECTION 2. ANODE 3. ANODE 4. NO CONNECTION 5. ANODE 6. NO CONNECTION 7. ANODE 8. ANODE 9. ANODE 10. NO CONNECTION 11. ANODE 12. ANODE 13. NO CONNECTION 14. COMMON CATHODE | STYLE 4: PIN 1. NO CONNECTION 2. CATHODE 3. CATHODE 4. NO CONNECTION 5. CATHODE 6. NO CONNECTION 7. CATHODE 8. CATHODE 10. NO CONNECTION 11. CATHODE 12. CATHODE 13. NO CONNECTION 14. COMMON ANODE |
|---|---|---|---|
| STYLE 5: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. ANODE/CATHODE 5. ANODE/CATHODE 6. NO CONNECTION 7. COMMON ANODE 8. COMMON CATHODE 9. ANODE/CATHODE 10. ANODE/CATHODE 11. ANODE/CATHODE 12. ANODE/CATHODE 13. NO CONNECTION 14. COMMON ANODE | STYLE 6: PIN 1. CATHODE 2. CATHODE 3. CATHODE 4. CATHODE 5. CATHODE 6. CATHODE 7. CATHODE 8. ANODE 9. ANODE 10. ANODE 11. ANODE 12. ANODE 13. ANODE 14. ANODE | STYLE 7: PIN 1. ANODE/CATHODE 2. COMMON ANODE 3. COMMON CATHODE 4. ANODE/CATHODE 5. ANODE/CATHODE 6. ANODE/CATHODE 7. ANODE/CATHODE 9. ANODE/CATHODE 10. ANODE/CATHODE 11. COMMON CATHODE 12. COMMON CATHODE 13. ANODE/CATHODE 14. ANODE/CATHODE | STYLE 8: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. NO CONNECTION 5. ANODE/CATHODE 6. ANODE/CATHODE 7. COMMON ANODE 8. COMMON ANODE 9. ANODE/CATHODE 10. ANODE/CATHODE 11. NO CONNECTION 12. ANODE/CATHODE 13. ANODE/CATHODE 14. COMMON CATHODE |

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